

## Features

- Hermetic 4-pin LCC package
- 1000Vdc isolation voltage
- High CTR
- Small package outline
- High reliability and rugged construction
- High reliability screening available
- DC input with transistor output
- Operating temperature range -55°C to +125°C

## Applications

- Switch mode power supplies
- Computer peripheral interface
- Motor control
- Ground signal isolation

## Description

The IBS010 consists of a phototransistor optically coupled to an AlGaAs infrared-emitting diode in a leadless hermetic surface mount package.

## Schematic Diagram

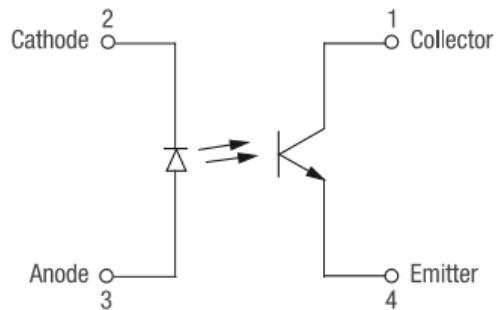


Figure 1. IBS010 Schematic Diagram

## Package Dimensions in inches (mm)

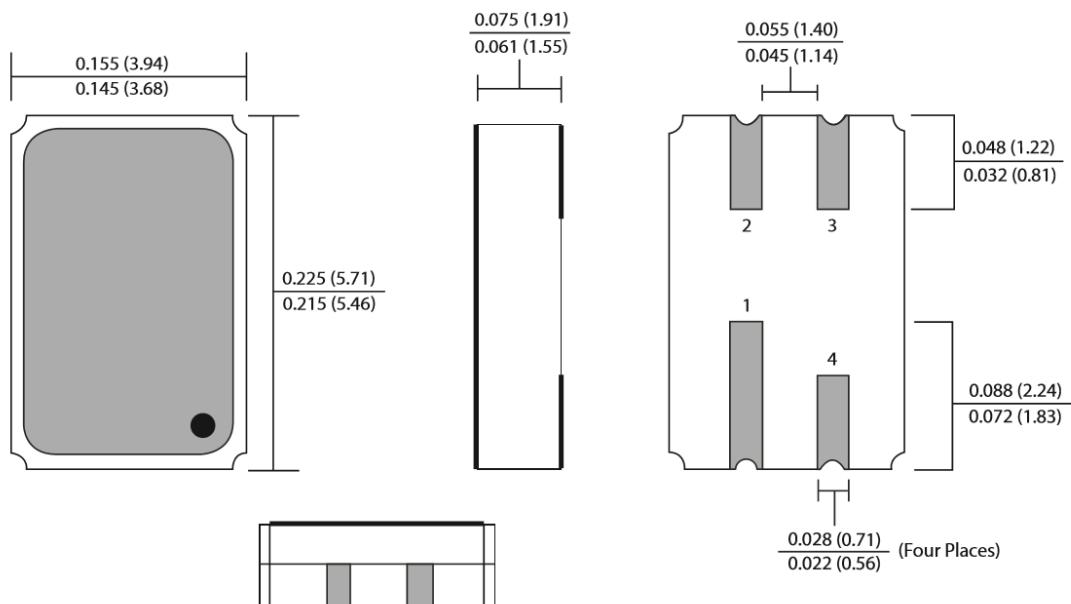


Figure 2. IBS010 Package Dimensions

**Absolute Maximum Rating at 25°C (Note 1)**

<b>Symbol</b>	<b>Parameters</b>	<b>Ratings</b>	<b>Units</b>	<b>Notes</b>
V <sub>DC</sub>	Isolation voltage	-1000 to +1000	V	2
T <sub>OPR</sub>	Operating temperature	-55 to +125	°C	
T <sub>TSG</sub>	Storage temperature	-65 to +150	°C	
T <sub>SOL</sub>	Soldering temperature (10 seconds maximum)	240	°C	
<b>Emitter</b>				
P <sub>D</sub>	Emitter power dissipation	60	mW	3
I <sub>F</sub>	Forward current	40	mA	
I <sub>F(TRANS)</sub>	Peak transient current (≤1ms)	1	A	
V <sub>R</sub>	Reverse voltage	2	V	
<b>Detector</b>				
P <sub>D</sub>	Detector power dissipation	300	mW	4
V <sub>CE</sub>	Collector-Emitter Voltage	60	V	
V <sub>EC</sub>	Emitter-Collector Voltage	5	V	
I <sub>CC</sub>	Continuous Collector Current	50	mA	

**Notes**

1. When using this product, please observe the absolute maximum ratings. Only one parameter may be set at the limit to ensure no damage to the device. Exceeding any of the limits listed here may damage the device.
2. Measured between input pins 2 and 3 shorted together, and output pins 1 and 4 shorted together. T<sub>A</sub> = 25°C and duration = 1sec.
3. Linear derating factor: 1.0 mW/°C above 65°C
4. Linear derating factor: 3.0 mW/°C above 25°C

**ESD Precaution**

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

## Electrical Characteristics $T_A = -55^\circ\text{C}$ to $125^\circ\text{C}$ (unless otherwise specified) (Note 1)

### Emitter Characteristics

Symbol	Parameters	Test Conditions	Min	Max	Units	Notes
$V_F$	Forward Voltage	$I_F=10\text{mA}$ , $T_A = -55^\circ\text{C}$	1.1	1.8	V	
		$I_F=10\text{mA}$ , $T_A = 25^\circ\text{C}$	0.9	1.6	V	
		$I_F=10\text{mA}$ , $T_A = 100^\circ\text{C}$	0.7	1.3	V	
$I_R$	Reverse Current	$V_R = 2\text{V}$		-	100	$\mu\text{A}$

### Detector Characteristics

Symbol	Parameters	Test Conditions	Min	Max	Units	Notes
$BV_{CEO}$	Collector-Emitter Breakdown Voltage	$I_{CE}=1\text{mA}$ , $T_A = 25^\circ\text{C}$	60	-	V	
$BV_{ECO}$	Emitter-Collector Breakdown Voltage	$I_{EC}=100\mu\text{A}$ , $T_A = 25^\circ\text{C}$	5	-	V	
$I_{C\_ON}$	Collector Current, On-state	$V_{CE}=5\text{V}$ , $I_F=1\text{mA}$	1.0	-	mA	
		$V_{CE}=5\text{V}$ , $I_F=10\text{mA}$	1.0	-	mA	
$I_{CE\_OFF}$	Collector-Emitter Dark Current, Off-state	$V_{CE}=20\text{V}$ , $T_A = 25^\circ\text{C}$	-	100	nA	
		$V_{CE}=20\text{V}$ , $T_A = 100^\circ\text{C}$	-	100	$\mu\text{A}$	

### Transfer Characteristics

Symbol	Parameters	Test Conditions	Min	Max	Units	Notes
$V_{CE(\text{SAT})}$	Collector-Emitter Saturation Voltage	$I_F= 10\text{mA}$ , $I_C= 2\text{mA}$	-	0.3	V	
$R_{IO}$	Isolation Resistance	$V_{IO}= \pm 1000\text{V}_{\text{DC}}$	$10^{11}$	-	$\Omega$	2
$C_{IO}$	Isolation Capacitance	$f= 1\text{MHz}$ , $V_{IO}= 0\text{V}$	-	5	pF	2

### Switching Characteristics

Symbol	Parameters	Test Conditions	Min	Max	Units	Notes
$t_r$	Rise Time	$I_F= 10\text{mA}$ , $V_{CC}= 10\text{V}$ , $R_L= 100\Omega$	-	20	$\mu\text{s}$	3
$t_f$	Fall Time		-	20		3

### Notes

1. Performance guaranteed only under conditions listed in above tables.
2. Measured between input pins 2 and 3 shorted together, and output pins 1 and 4 shorted together.  $T_A = 25^\circ\text{C}$  and duration = 1sec.
3. Value applies for PW  $\leq 1\ \mu\text{s}$ , 300 pps.

## Typical Characteristic Curves

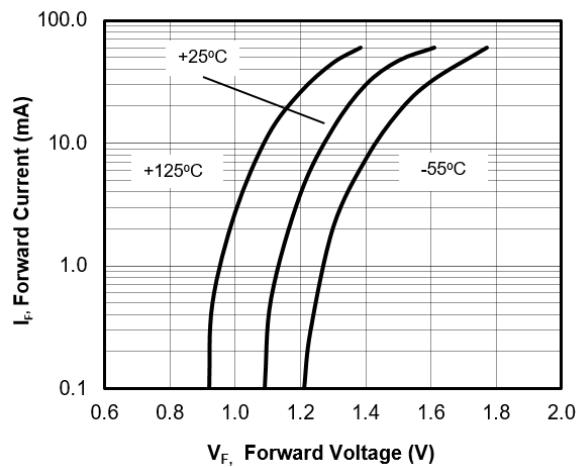


Figure 3. Forward Current vs Forward Voltage

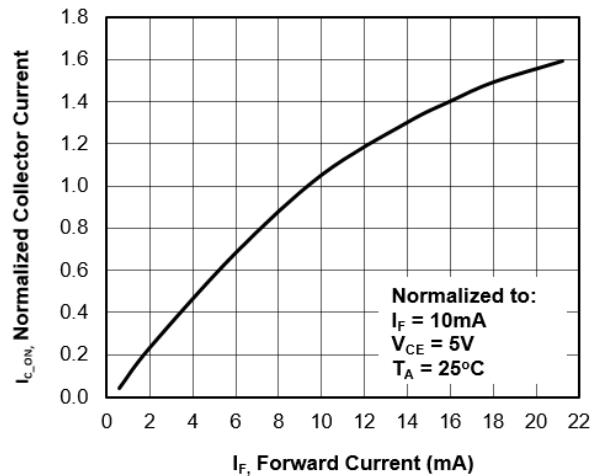


Figure 4. Collector Current vs Forward Current

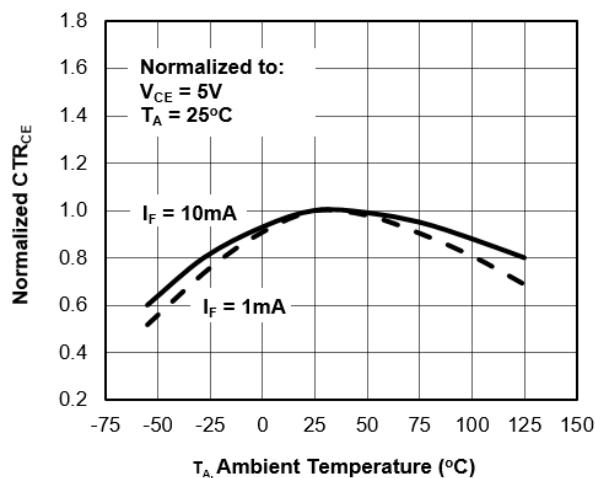


Figure 5. Normalized CTR<sub>CE</sub> vs Temperature

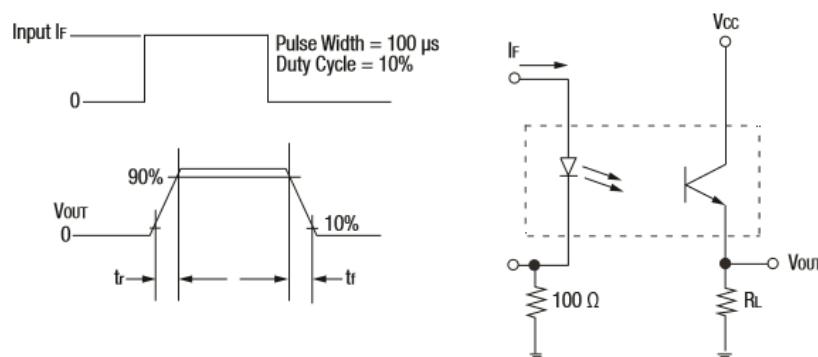


Figure 6. IBS010 Switching Test Circuit



Miniature Phototransistor  
Hermetic Surface Mount Optocoupler

**IBS010**

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## Ordering Information

<b><i>Manufacturing Part Number</i></b>	<b><i>Part Description</i></b>
IBS010	Miniature Phototransistor Hermetic 4-pin LCC Package

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